



TOLERANCE:  $\pm 0.05$   
 RECOMMENDED P.C.B. Layout  
 TOP VIEW

Mating Condition (REF.)

PIN	DIM. (mm)		PIN	DIM. (mm)	
	A	B		A	B
02	1.25	6.10	09	10.00	14.85
03	2.50	7.35	10	11.25	16.10
04	3.75	8.60	14	16.25	21.10
05	5.00	9.85	15	17.50	22.35
06	6.25	11.10	20	23.75	28.60
07	7.50	12.35	25	30.00	34.85
08	8.75	13.60	30	36.25	41.10

NOTES:

- MATERIAL:  
 INSULATION(STANDARD): NYLON 9T, UL94V-0  
 INSULATION(HALOGEN FREE): NYLON 9T, UL94V-0  
 CONTACT: COPPER ALLOY,  $t=0.30\text{mm}$   
 SOLDER TAB: COPPER ALLOY,  $t=0.25\text{mm}$  / MATTE-TIN PLATED OVER NICKEL
- CONTACT FINISH: (VOID)--MATTE-TIN PLATED OVER NICKEL  
 GO--GOLD FLASH OVER NICKEL

<b>RoHS</b> <b>Compliant</b>	<b>HSM 玄茂科技股份有限公司</b> <b>HSUAN MAO TECHNOLOGY CO., LTD.</b>		
	APPD. 核准 DWG. 製圖 DATE 制表日 2015/07/14	Hedy 1 / 1	TOLERANCE X.X $\pm 0.25$ X.XX $\pm 0.15$ ANGULA 3° SIZE. 紙張尺寸 A 4 REV. 版次 B
	PART NAME 品名 1.25mm WAFER SMT RIGHT ANGLE TYPE 1XXXP TIN PLATING REEL PACKING IVORY(CREAM) COLOR ROHS		
	PART NO. 料號 W1258-XXPBTR10R		